## 捷多邦,专**SN54CBTT6242A**th**SNT4C**BT16212A 24-BIT FET BUS-EXCHANGE SWITCHES

SCDS007M - NOVEMBER 1992 - REVISED SEPTEMBER 1998

- 5-Ω Switch Connection Between Two Ports
- TTL-Compatible Input Levels
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds 2000 V Per MIL-STD-833, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Package Options Include Plastic Thin Shrink Small-Outline (DGG), Thin Very Small-Outline (DGV), and Shrink Small-Outline (DL) Packages, and Ceramic Flat (WD) Package

#### description

The 'CBT16212A devices provide 24 bits of high-speed TTL-compatible bus switching or exchanging. The low on-state resistance of the switch allows connections to be made with minimal propagation delay.

Each device operates as a 24-bit bus switch or a 12-bit bus exchanger, which provides data exchanging between the four signal ports via the data-select (S0, S1, S2) terminals.

The SN54CBT16212A is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74CBT16212A is characterized for operation from -40°C to 85°C.

SN54CBT16212A . . . WD PACKAGE SN74CBT16212A . . . DGG, DGV, OR DL PACKAGE (TOP VIEW)

1			
S0 [	1	56	S1
1A1	2	55	S2
1A2	3	54	1B1
2A1	4	53	1B2
2A2 [	5	52	2B1
3A1 🛚	6	51	2B2
3A2 🛚	7	50	3B1
GND [	8	49	GND
4A1	9	48	3B2
4A2	10	47	4B1
5A1	11	46	4B2
5A2	12	45	5B1
6A1	13	44	5B2
6A2	14	43	6B1
7A1	15	42	6B2
7A2	16	41	7B1
v <sub>cc</sub> [	17	40	7B2
8A1	18	39	8B1
GND [	19	38	GND
8A2	20	37	8B2
9A1 L	21	36	9B1
9A2	22	35	9B2
10A1	23	34	10B1
10A2	24	33	10B2
11A1	25	32	11B1
11A2	26	31	11B2
12A1 [	27	30	12B1
12A2 [	28	29	12B2

#### **FUNCTION TABLE**

	INPUTS		INPUTS/0	OUTPUTS	FUNCTION		
S2	S1	S0	A1	A2	FUNCTION		
L	L	L	Z	Z	Disconnect		
L	L	Н	B1 port	Z	A1 port = B1 port		
L	Н	L	B2 port	Z	A1 port = B2 port		
L	Н	Н	Z	B1 port	A2 port = B1 port		
Н	L	L	Z	B2 port	A2 port = B2 port		
Н		Н	Z	Z	Disconnect		
Н	o Hs	, E <sup>01</sup>	B1 port	B2 port	A1 port = B1 port A2 port = B2 port		
Н	Н	Н	B2 port	B1 port	A1 port = B2 port A2 port = B1 port		

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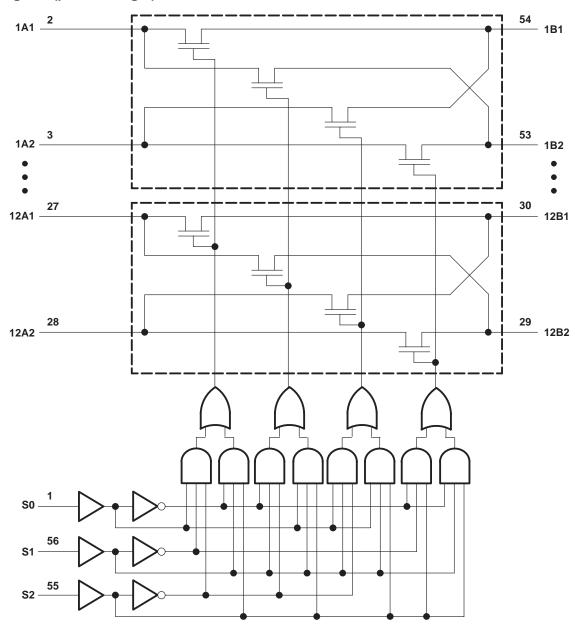


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## logic diagram (positive logic)



Pin numbers shown are for the DGG, DGV, and DL packages.



## SN54CBT16212A, SN74CBT16212A 24-BIT FET BUS-EXCHANGE SWITCHES

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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub>		
Input voltage range, V <sub>I</sub> (see Note 1)		–0.5 V to 7 V
Continuous channel current		128 mA
Input clamp current, $I_{IK}$ ( $V_I < 0$ )		
Package thermal impedance, θ <sub>JA</sub> (see Note 2):	DGG package	81°C/W
	DGV package	86°C/W
	DL package	74°C/W
Storage temperature range, T <sub>stg</sub>		–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

### recommended operating conditions (see Note 3)

		SN54CBT	16212A	SN74CBT	UNIT	
		MIN	MAX	MIN	MAX	UNIT
Vcc	Supply voltage	4	5.5	4	5.5	V
VIH	High-level control input voltage	2		2		V
V <sub>IL</sub>	Low-level control input voltage		0.8		0.8	V
TA	Operating free-air temperature	-55	125	-40	85	°C

NOTE 3: All unused control inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS			SN54CBT16212A			SN74CBT16212A			UNIT	
PARA	NVIETER	TEST CON	DITIONS		MIN	TYP‡	MAX	MIN	TYP‡	MAX	Oldiii	
٧ <sub>IK</sub>		$V_{CC} = 4.5 \text{ V},$	I <sub>I</sub> = -18 mA				-1.2			-1.2	V	
$V_{CC} = 0,$ $V_{I} = 5.5 \text{ V}$				10			10					
=		V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 5.5 V o	r GND			±1			±1	μΑ	
ICC		$V_{CC} = 5.5 \text{ V},$ $V_{I} = V_{CC} \text{ or GND}$	I <sub>O</sub> = 0,				3.2			3	μΑ	
ΔICC§	Control inputs	V <sub>CC</sub> = 5.5 V, Other inputs at V <sub>CC</sub> or GND	One input at 3.4 V,				2.5			2.5	mA	
Ci	Control inputs	V <sub>I</sub> = 3 V or 0				2.5			2.5		pF	
C <sub>io(OFF</sub>	=)	$V_O = 3 V \text{ or } 0,$	S0, S1, or S	2 = V <sub>C</sub> C		7.5			7.5		pF	
		$V_{CC} = 4 \text{ V},$ TYP at $V_{CC} = 4 \text{ V}$	V <sub>I</sub> = 2.4 V,	I <sub>I</sub> = 15 mA		14	20		14	20		
r <sub>on</sub> ¶			\/ı = 0	I <sub>I</sub> = 64 mA		4	10		4	7	Ω	
		V <sub>CC</sub> = 4.5 V	V <sub>I</sub> = 0	I <sub>I</sub> = 30 mA		4	10		4	7		
			$V_{I} = 2.4 V$ ,	I <sub>I</sub> = 15 mA		6	14		6	12		

<sup>‡</sup> All typical values are at  $V_{CC} = 5 \text{ V}$  (unless otherwise noted),  $T_A = 25^{\circ}\text{C}$ .



<sup>2.</sup> The package thermal impedance is calculated in accordance with JESD 51.

<sup>§</sup> This is the increase in supply current for each input that is at the specified TTL voltage level rather than VCC or GND.

Measured by the voltage drop between the A and B terminals at the indicated current through the switch. On-state resistance is determined by the lower of the voltages of the two (A or B) terminals.

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# switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

			S	SN54CBT16212A				SN74CBT16212A			
PARAMETER	FROM (INPUT)	TO (OUTPUT)	VCC:	V <sub>CC</sub> = 4 V		V <sub>CC</sub> = 5 V ± 0.5 V		V <sub>CC</sub> = 4 V		V <sub>CC</sub> = 5 V ± 0.5 V	
			MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t <sub>pd</sub> †	A or B	B or A				0.8*		0.35		0.25	ns
t <sub>pd</sub>	S	A or B		14	1.5	13		10	1.5	9.1	ns
t <sub>en</sub>	S	A or B		15	1.5	13.7		10.4	1.5	9.7	ns
<sup>t</sup> dis	S	A or B		14.2	1.5	13.5		9.2	1.5	8.8	ns

<sup>\*</sup> On products compliant to MIL-PRF-38535, this parameter is not production tested.

#### PARAMETER MEASUREMENT INFORMATION **TEST S1** 500 $\Omega$ From Output Open tpd **Under Test ♀ GND** 7 V tPLZ/tPZL $C_L = 50 pF$ tPHZ/tPZH Open 500 $\Omega$ (see Note A) Output 3 V Control 1.5 V 1.5 V (low-level **LOAD CIRCUIT** enabling) n v tpzl **t**PLZ Output 3.5 V Waveform 1 Input S1 at 7 V $V_{OL} + 0.3 V$ (see Note B) $v_{OL}$ tPHZtPZH → **tPLH tPHL** Output ۷он VOH Waveform 2 V<sub>OH</sub> – 0.3 V 1.5 V 1.5 V Output S1 at Open n v (see Note B) VOL **VOLTAGE WAVEFORMS VOLTAGE WAVEFORMS PROPAGATION DELAY TIMES ENABLE AND DISABLE TIMES**

NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.

  Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_Q = 50 \Omega$ ,  $t_f \leq$  2.5 ns,  $t_f \leq$  2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpZL and tpZH are the same as ten.
- G. tplH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms

<sup>†</sup> The propagation delay is the calculated RC time constant of the typical on-state resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).

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